

Silicon Diode

1N5062GP

800V / 1A

DATASHEET

OEM – General Semiconductor

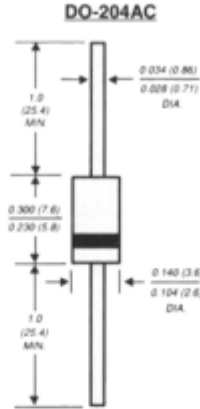
Source: General Semiconductor Databook 1998

1N5059GP THRU 1N5062GP

GLASS PASSIVATED JUNCTION RECTIFIER

Reverse Voltage - 200 to 800 Volts Forward Current - 1.0 Ampere

PATENTED*



Dimensions in inches and (millimeters)

* Glass-plastic encapsulation technique is covered by Patent No. 3,996,602 and brazed-lead assembly by Patent No. 3,930,306



FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- High temperature metallurgically bonded construction
- Glass passivated cavity-free junction
- Capable of meeting environmental standards of MIL-S-19500
- 1.0 Ampere operation at $T_A=75^\circ\text{C}$ with no thermal runaway
- Typical I_R less than $0.1\mu\text{A}$
- High temperature soldering guaranteed: $350^\circ\text{C}/10$ seconds, $0.375"$ (9.5mm) lead length at 5 lbs., (2.3kg) tension

MECHANICAL DATA

Case: JEDEC DO-204AC molded plastic over glass body
Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight: 0.015 ounce, 0.4 gram

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

	SYMBOLS	1N5059GP	1N5060GP	1N5061GP	1N5062GP	UNITS
* Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	Volts
Maximum RMS voltage	V_{RMS}	140	280	420	560	Volts
* Maximum DC blocking voltage	V_{DC}	200	400	600	800	Volts
* Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A=75^\circ\text{C}$	$I_{(AV)}$	1.0				Amp
* Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	50.0				Amps
* Maximum instantaneous forward voltage at 1.0A, $T_A=75^\circ\text{C}$	V_F	1.2				Volts
* Maximum full load reverse current, full cycle average 0.375" (9.5mm) lead length at $T_A=25^\circ\text{C}$ $T_A=75^\circ\text{C}$	$I_{R(AV)}$	5.0 150.0				μA
* Maximum DC reverse current at rated DC blocking voltage $T_A=25^\circ\text{C}$ $T_A=175^\circ\text{C}$	I_R	5.0 300.0				μA
Typical reverse recovery time (NOTE 1)	t_{rr}	2.0				μs
Typical junction capacitance (NOTE 2)	C_J	15.0				pF
Typical thermal resistance (NOTE 3)	$R_{\theta JA}$ $R_{\theta JL}$	45.0 20.0				$^\circ\text{C}/\text{W}$
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +175				$^\circ\text{C}$

NOTES:

- (1) Reverse recovery test conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_T=0.25\text{A}$
 - (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Vdc
 - (3) Thermal resistance from junction to ambient and from junction to lead at 0.375" (9.5mm) lead length, P.C.B. mounted
- * JEDEC registered value

RATINGS AND CHARACTERISTIC CURVES 1N5059GP THRU 1N5062GP

